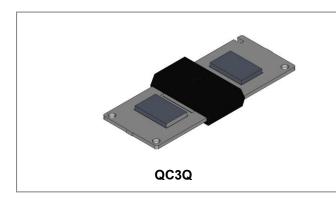


GF4045TS-1

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# **GF4045TS-1** Power Schottky Module Bypass Diode



### Features

- Low thermal resistance
- Lower forward voltage drop, low power loss
- Isolate Package design, ideal for heat dispersion
- High forward current capability
- Trench MOS Schottky technology
- Excellent anti-humidity
- Low profile package
- High forward surge capability
- All SMC parts are traceable to the wafer lot
- Additional electrical and life testing can be performed upon request

#### **Mechanical Data**

- Case: QC3Q
- High temperature soldering guaranteed
- Heated-tool welding 260℃,10 seconds
- Marking Code: GF4045TS-1

#### Maximum Ratings(limiting values, at 25 °C unless otherwise specified)

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	-	45	V
Average Rectified Forward Current	I <sub>F (AV)</sub>	Tc=110°C, In DC	40	А
Peak One Cycle Non-Repetitive Surge Current	IFSM	8.3 ms, half Sine pulse, T <sub>J</sub> = 25 °C	350	А
Rating for fusing (t<8.3ms)	l²t	T <sub>J</sub> = 25 °C	500	A <sup>2</sup> sec

### **Electrical Characteristics**

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop*	V <sub>F1</sub>	@ 40A, Pulse, T <sub>J</sub> = 25 °C	0.48	0.52	V
Reverse Current*	I <sub>R1</sub>	$@V_R$ = rated $V_R$ T <sub>J</sub> = 25 °C	0.03	0.20	mA
	I <sub>R2</sub>	$@V_R = rated V_R T_J = 100 \ ^{\circ}C$	-	12	mA
	I <sub>R3</sub>	@V <sub>R</sub> = rated V <sub>R</sub> T <sub>J</sub> = 125 °C	26	55	mA
Junction Capacitance	CT	@V <sub>R</sub> = 5V, T <sub>C</sub> = 25 °C f <sub>SIG</sub> = 1MHz	5840	-	pF

\* Pulse width < 300  $\mu$ s, duty cycle < 2%

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**Technical Data** 

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## Thermal-Mechanical Specifications

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	IN DC Forward Mode, without reverse bias, t $\leq$ 1 h	-55 to +200	°C
Storage Temperature	T <sub>stg</sub>	-	-55 to +150	°C
Typical Thermal Resistance Junction to Case	$R_{ ext{ heta}JC}$	-	1.5	°C/W

100

**Ratings and Characteristics Curves** 

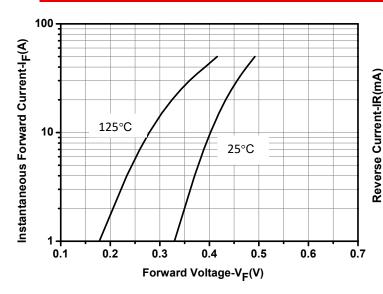


Fig.1-Typical Forward Voltage Characteristics

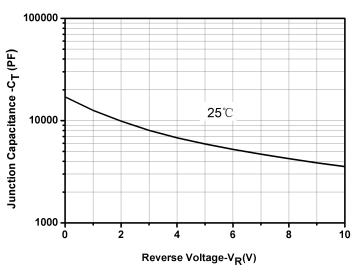
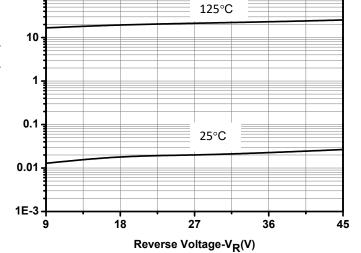


Fig.3-Capacitance vs. Reverse Voltage

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**Fig.2-Typical Reverse Characteristics** 



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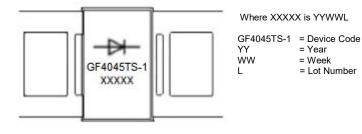
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## **Ordering Information**

Device	Package	Shipping
GF4045TS-1	QC3Q	32pcs/Tube

## Marking Diagram

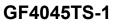


Order P/N	Terminals	Additional	
GF4045TS-1-S1	Tin Plated	None	Solder Paste
GF4045TS-1-S2	Tin Plated	Solder Paste □	
GF4045TS-1-S3	Tin Plated	Solder Block	
GF4045TS-1-N1	Nickel Plated	None	
GF4045TS-1-N2	Nickel Plated	Solder Paste	Solder Block
GF4045TS-1-N3	Nickel Plated	Solder Block	

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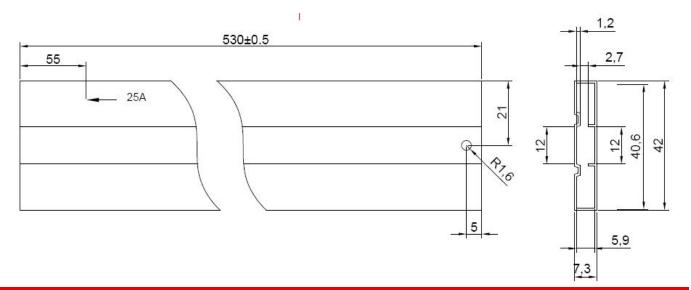




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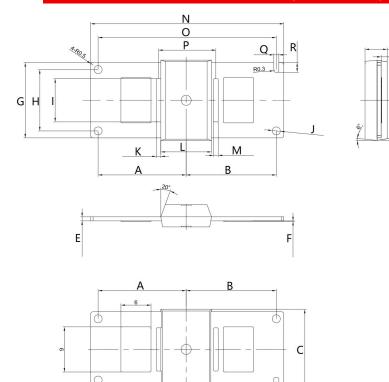
## Tube Specification QC3Q (Millimeters)



Т

S

## Mechanical Dimensions QC3Q (Millimeters)



Symbol	Dimensions in millimeters			
	Min.	Typical	Max	
A		17.54		
В		17.96		
С	15.90	16.00	16.10	
E	0.77	0.80	0.83	
F	0.08	0.10	0.12	
G	14.90	15.00	15.10	
Н	12.15	12.20	12.25	
I	8.55	8.60	8.65	
J		1.60	1.70	
K	0.86	0.90	0.93	
L	10.00	10.10	10.20	
М	0.87	0.90	0.93	
N	38.40	38.50	38.60	
0	35.45	35.50	35.55	
Р	11.32	11.42	11.52	
Q		1.00	1.10	
R		1.90	2.00	
S	1.15	1.20	1.25	
Т	4.30	4.40	4.50	

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